TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (π -MOS V)

2SK4026

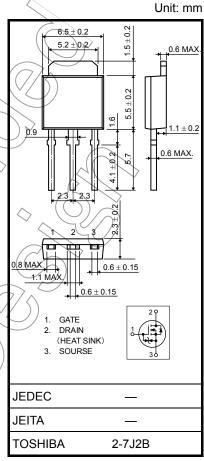
Switching Regulator Applications

Features

- Low drain-source ON-resistance: R_{DS} (ON) = 6.4 Ω (typ.)
- High forward transfer admittance: $|Y_{fS}| = 0.85 \text{ S (typ.)}$
- Low leakage current: I_{DSS} = 100 μ A (max) (V_{DSS} = 600 V)
- Enhancement mode: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-source voltage			V_{DSS}	600	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)			V_{DGR}	600	У
Gate-source voltage			V_{GSS}	±30	> v
Drain current	DC	(Note 1)	ΙD		Α
	Pulse	(Note 1)	I _{DP}	2	A
Drain power dissipation (Tc = 25°C)			P _D <	20	W
Single pulse avalanche energy (Note 2)			EAS	56	m)
Avalanche current			JAR	<u> 1</u>	Α
Repetitive avalanche energy (Note 3)			(EAR	2	mJ
Channel temperature			Tch	150	~c
Storage temperature range			√T _{stg}	-55 to 150	√,c
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Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in

temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	6.25	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	125	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$, L = 100 mH, $I_{AR} = 1 \text{ A}$, $R_G = 25 \Omega$

Note 3: Repetitive rating: pulse width limited by max channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.

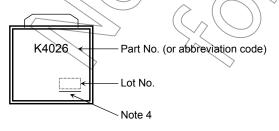
Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Gate-source breakdown voltage		V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_	_	V
Drain cutoff current		I _{DSS}	V _{DS} = 600 V, V _{GS} = 0 V	/	_	100	μА
Drain-source breakdown voltage		V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	600	_	_	V
Gate threshold voltage		V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0) >	4.0	V
Drain-source ON-resistance		R _{DS} (ON)	V _{GS} = 10 V, I _D = 0.5 A	<u> </u>	6.4	9.0	Ω
Forward transfer admittance		Y _{fs}	V _{DS} = 10 V, I _D = 0.5 A	0.4	0.85		S
Input capacitance		C _{iss}			190		
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	15		pF
Output capacitance		Coss			55		
Switching time	Rise time	t _r	10 V V _{GS} 0 V R _L = 600 Ω	- (12	γ 1	
	Turn-on time	t _{on}		_((55) —	
	Fall time	t _f	S	7	> 40	_	ns
	Turn-off time	t _{off}	Duty ≤ 1%, t _W = 10 μs		90		
Total gate charge (gate-source plus gate-drain)		Qg) —	9	_	
Gate-source charge		Qgs	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 1 \text{ A}$	_	3.5	_	nC
Gate-drain ("Miller") charge		Qgd		_	5.5	_	

Source-Drain Diode Ratings and Characteristics (Ta = 25°C)

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Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current	I _{DR}	(7) ~ -	_	_	1	Α
Pulse drain reverse current	I _{DRP}		_	_	2	Α
Diode forward voltage	VDSF	1 _{DR} = 1 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	tir	I _{DR} = 1 A, V _{GS} = 0 V,	_	400	_	ns
Reverse recovery charge	Qrr	dl _{DR} /dt = 100 A/μs	_	1.4	_	μС

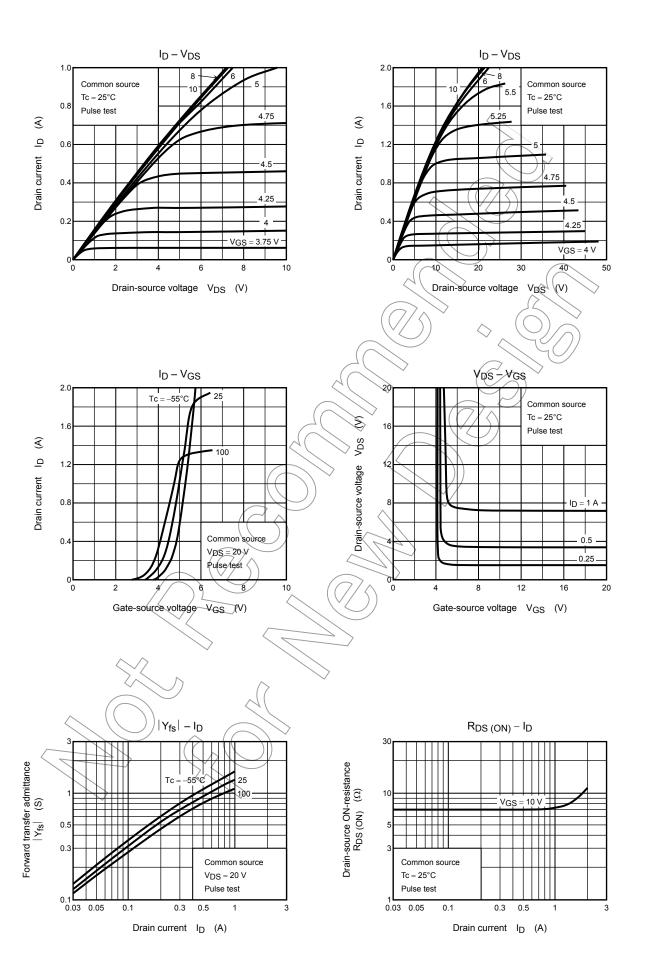
Marking

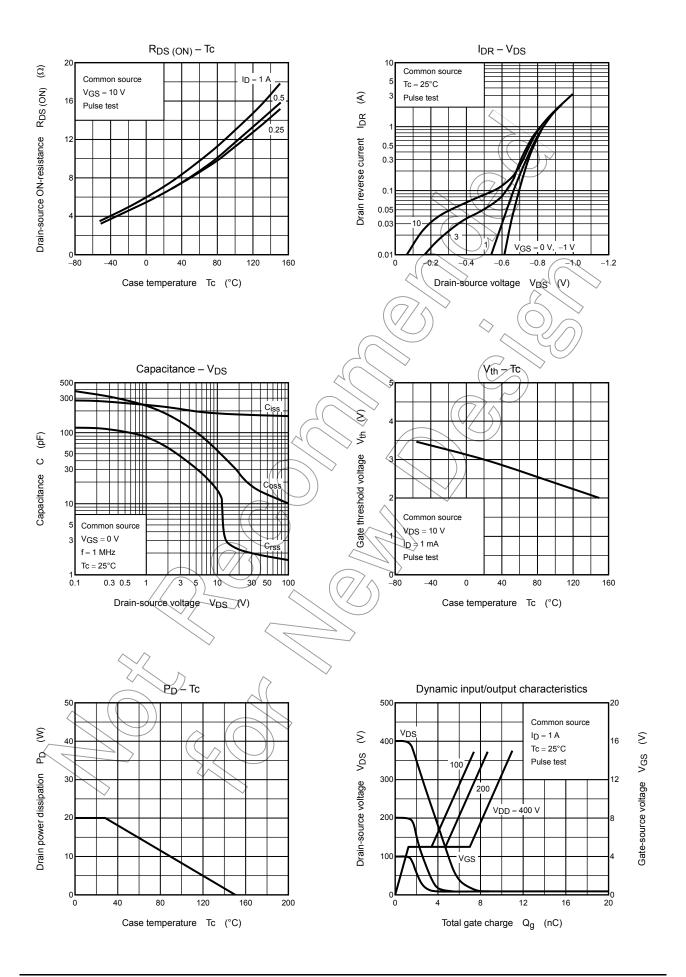


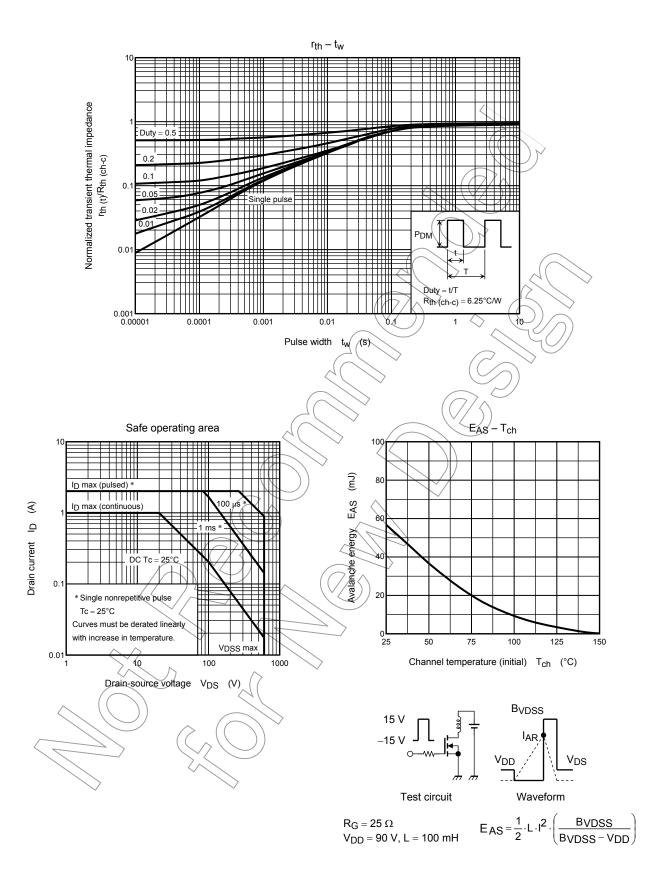
Note 4: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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